

## Power MOSFET

### PRODUCT SUMMARY

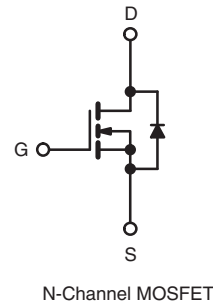
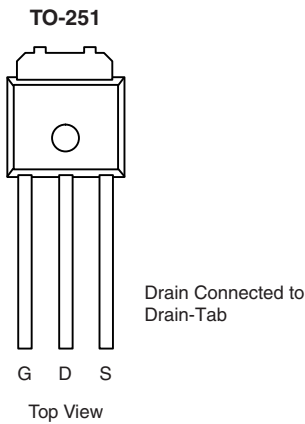
|                           |                        |     |
|---------------------------|------------------------|-----|
| $V_{DS}$ (V)              | 700                    |     |
| $R_{DS(on)}$ ( $\Omega$ ) | $V_{GS} = 10\text{ V}$ | 6.5 |
| $Q_g$ (Max.) (nC)         | 38                     |     |
| $Q_{gs}$ (nC)             | 5.0                    |     |
| $Q_{gd}$ (nC)             | 21                     |     |
| Configuration             | Single                 |     |

### FEATURES

- Dynamic  $dV/dt$  Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



Available  
**RoHS\***  
 COMPLIANT



### ABSOLUTE MAXIMUM RATINGS ( $T_C = 25\text{ }^\circ\text{C}$ , unless otherwise noted)

| PARAMETER  |                                    |                                     | SYMBOL         | LIMIT            | UNIT                  |
|--|------------------------------------|-------------------------------------|----------------|------------------|-----------------------|
| Drain-Source Voltage                             |                                    |                                     | $V_{DS}$       | 800              | V                     |
| Gate-Source Voltage                              |                                    |                                     | $V_{GS}$       | $\pm 20$         |                       |
| Continuous Drain Current                         | $V_{GS}$ at 10 V                   | $T_C = 25\text{ }^{\circ}\text{C}$  | $I_D$          | 2.0              | A                     |
|  |                                    | $T_C = 100\text{ }^{\circ}\text{C}$ |                | 1.4              |                       |
| Pulsed Drain Current <sup>a</sup>                |                                    |                                     | $I_{DM}$       | 7.2              |                       |
| Linear Derating Factor                           |                                    |                                     |                | 0.43             | W/ $^{\circ}\text{C}$ |
| Single Pulse Avalanche Energy <sup>b</sup>       |                                    |                                     | $E_{AS}$       | 180              | mJ                    |
| Repetitive Avalanche Current <sup>a</sup>        |                                    |                                     | $I_{AR}$       | 2.0              | A                     |
| Repetitive Avalanche Energy <sup>a</sup>         |                                    |                                     | $E_{AR}$       | 5.4              | mJ                    |
| Maximum Power Dissipation                        | $T_C = 25\text{ }^{\circ}\text{C}$ |                                     | $P_D$          | 54               | W                     |
| Peak Diode Recovery $dV/dt$ <sup>c</sup>         |                                    |                                     | $dV/dt$        | 2.0              | V/ns                  |
| Operating Junction and Storage Temperature Range |                                    |                                     | $T_J, T_{stg}$ | - 55 to + 150    | $^{\circ}\text{C}$    |
| Soldering Recommendations (Peak Temperature)     | for 10 s                           |                                     |                | 300 <sup>d</sup> |                       |
| Mounting Torque                                  | 6-32 or M3 screw                   |                                     |                | 10               | lbf · in              |
|  |                                    |                                     |                | 1.1              | N · m                 |

#### Notes



- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- $V_{DD} = 50\text{ V}$ , starting  $T_J = 25\text{ }^\circ\text{C}$ ,  $L = 104\text{ mH}$ ,  $R_g = 25\text{ }\Omega$ ,  $I_{AS} = 1.8\text{ A}$  (see fig. 12).
- $I_{SD} \leq 1.8\text{ A}$ ,  $dI/dt \leq 80\text{ A}/\mu\text{s}$ ,  $V_{DD} \leq 600$ ,  $T_J \leq 150\text{ }^\circ\text{C}$ .
- 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

**THERMAL RESISTANCE RATINGS**

| PARAMETER                           | SYMBOL     | TYP. | MAX. | UNIT |
|-------------------------------------|------------|------|------|------|
| Maximum Junction-to-Ambient         | $R_{thJA}$ | -    | 62   | °C/W |
| Case-to-Sink, Flat, Greased Surface | $R_{thCS}$ | 0.50 | -    |      |
| Maximum Junction-to-Case (Drain)    | $R_{thJC}$ | -    | 2.3  |      |

**SPECIFICATIONS** ( $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)

| PARAMETER                                 | SYMBOL              | TEST CONDITIONS   |  | MIN. | TYP. | MAX.      | UNIT                        |
|---|---------------------|---|--|------|------|-----------|-----------------------------|
| Static                                    |                     |   |  |      |      |           |                             |
| Drain-Source Breakdown Voltage            | $V_{DS}$            | $V_{GS} = 0\text{ V}$ , $I_D = 250\text{ }\mu\text{A}$  |  | 700  | -    | -         | V                           |
| $V_{DS}$ Temperature Coefficient          | $\Delta V_{DS}/T_J$ | Reference to $25\text{ }^{\circ}\text{C}$ , $I_D = 1\text{ mA}$   |  | -    | 0.98 | -         | $\text{V}/^{\circ}\text{C}$ |
| Gate-Source Threshold Voltage             | $V_{GS(th)}$        | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$  |  | 2.0  | -    | 4.0       | V                           |
| Gate-Source Leakage                       | $I_{GSS}$           | $V_{GS} = \pm 20\text{ V}$  |  | -    | -    | $\pm 100$ | nA                          |
| Zero Gate Voltage Drain Current           | $I_{DSS}$           | $V_{DS} = 700\text{ V}$ , $V_{GS} = 0\text{ V}$   |  | -    | -    | 100       | $\mu\text{A}$               |
|   |                     | $V_{DS} = 560\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 125\text{ }^{\circ}\text{C}$   |  | -    | -    | 500       |                             |
| Drain-Source On-State Resistance          | $R_{DS(on)}$        | $V_{GS} = 10\text{ V}$  | $I_D = 1.1\text{ A}^b$   | -    | 6.5  | -         | $\Omega$                    |
| Forward Transconductance                  | $g_{fs}$            | $V_{DS} = 100\text{ V}$ , $I_D = 1.1\text{ A}^b$  |  | 0.80 | -    | -         | S                           |
| Dynamic                                   |                     |   |  |      |      |           |                             |
| Input Capacitance                         | $C_{iss}$           | $V_{GS} = 0\text{ V}$ ,<br>$V_{DS} = 25\text{ V}$ ,<br>$f = 1.0\text{ MHz}$ , see fig. 5  |  | -    | 530  | -         | pF                          |
| Output Capacitance                        | $C_{oss}$           |   |  | -    | 150  | -         |                             |
| Reverse Transfer Capacitance              | $C_{rss}$           |   |  | -    | 90   | -         |                             |
| Total Gate Charge                         | $Q_g$               | $V_{GS} = 10\text{ V}$  | $I_D = 1.8\text{ A}$ , $V_{DS} = 350\text{ V}$ ,<br>see fig. 6 and 13 <sup>b</sup> | -    | -    | 38        | nC                          |
| Gate-Source Charge                        | $Q_{gs}$            |   |  | -    | -    | 5.0       |                             |
| Gate-Drain Charge                         | $Q_{gd}$            |   |  | -    | -    | 21        |                             |
| Turn-On Delay Time                        | $t_{d(on)}$         | $V_{DD} = 350\text{ V}$ , $I_D = 1.8\text{ A}$ ,<br>$R_g = 18\text{ }\Omega$ , $R_D = 230\text{ }\Omega$ , see fig. 10 <sup>b</sup>                       |  | -    | 8.2  | -         | ns                          |
| Rise Time                                 | $t_r$               |   |  | -    | 17   | -         |                             |
| Turn-Off Delay Time                       | $t_{d(off)}$        |   |  | -    | 58   | -         |                             |
| Fall Time                                 | $t_f$               |   |  | -    | 27   | -         |                             |
| Internal Drain Inductance                 | $L_D$               | Between lead, 6 mm (0.25") from package and center of die contact<br> |  | -    | 4.5  | -         | nH                          |
| Internal Source Inductance                | $L_S$               |   |  | -    | 7.5  | -         |                             |
| Drain-Source Body Diode Characteristics   |                     |   |  |      |      |           |                             |
| Continuous Source-Drain Diode Current     | $I_S$               | MOSFET symbol showing the integral reverse p - n junction diode<br>   |  | -    | -    | 1.8       | A                           |
| Pulsed Diode Forward Current <sup>a</sup> | $I_{SM}$            |   |  | -    | -    | 7.2       |                             |
| Body Diode Voltage                        | $V_{SD}$            | $T_J = 25\text{ }^{\circ}\text{C}$ , $I_S = 1.8\text{ A}$ , $V_{GS} = 0\text{ V}^b$   |  | -    | -    | 1.4       | V                           |
| Body Diode Reverse Recovery Time          | $t_{rr}$            | $T_J = 25\text{ }^{\circ}\text{C}$ , $I_F = 1.8\text{ A}$ , $dI/dt = 100\text{ A}/\mu\text{s}^b$  |  | -    | 380  | 570       | ns                          |
| Body Diode Reverse Recovery Charge        | $Q_{rr}$            |   |  | -    | 0.94 | 1.4       | $\mu\text{C}$               |
| Forward Turn-On Time                      | $t_{on}$            | Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )   |  |      |      |           |                             |

**Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).  
 b. Pulse width  $\leq 300\text{ }\mu\text{s}$ ; duty cycle  $\leq 2\%$ .

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

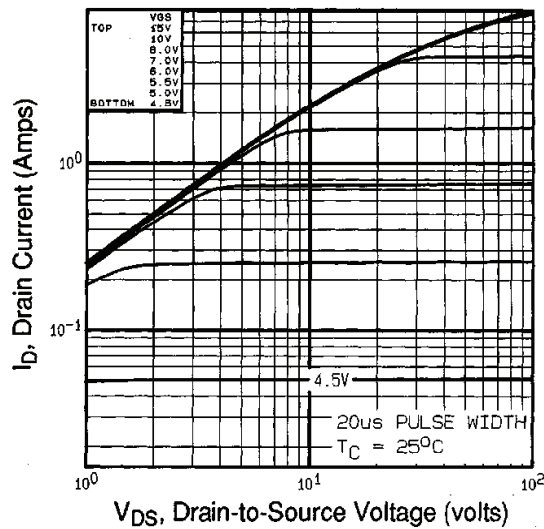


Fig. 1 - Typical Output Characteristics,  $T_C = 25\text{ }^{\circ}\text{C}$

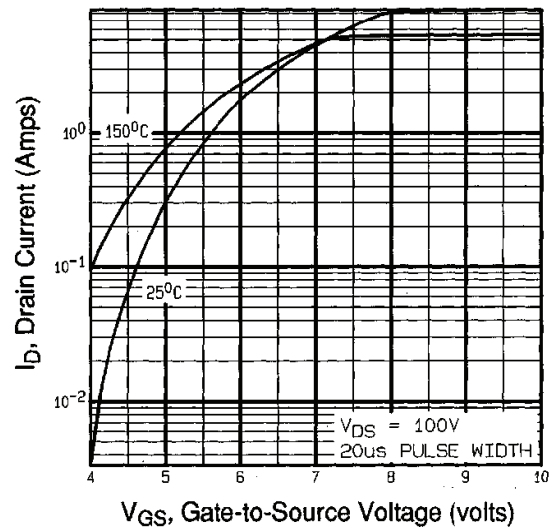


Fig. 3 - Typical Transfer Characteristics

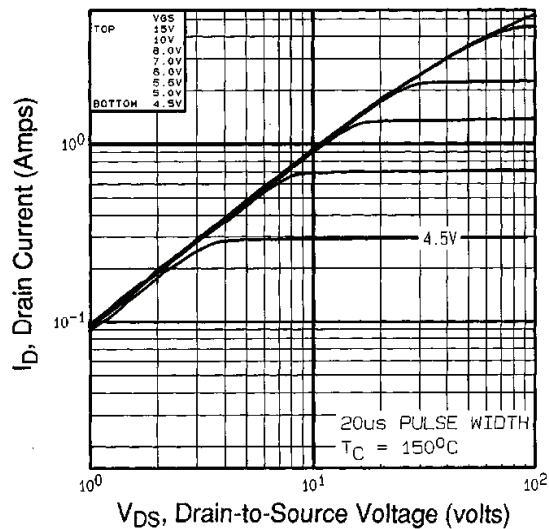


Fig. 2 - Typical Output Characteristics,  $T_C = 150\text{ }^{\circ}\text{C}$

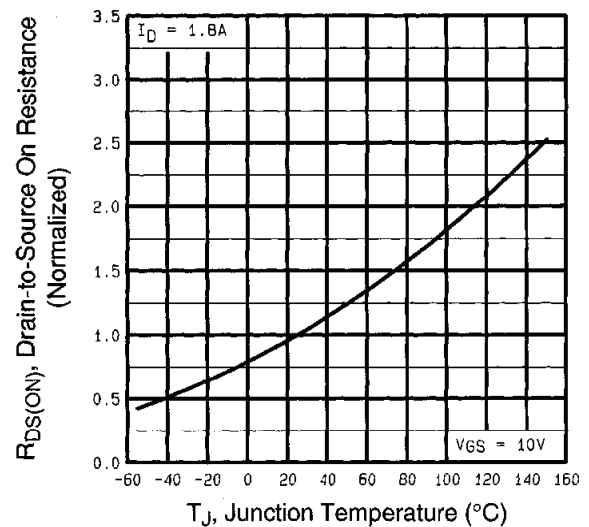


Fig. 4 - Normalized On-Resistance vs. Temperature

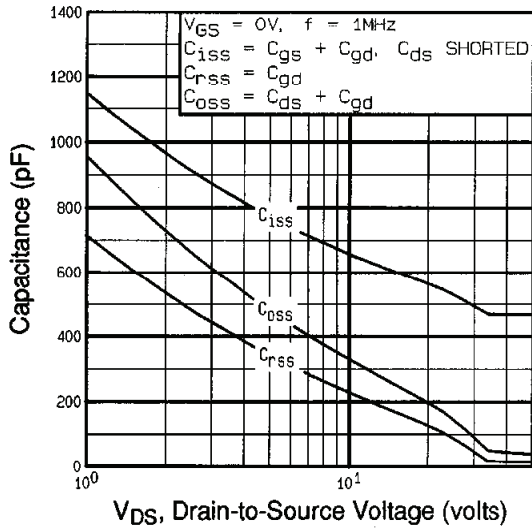


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

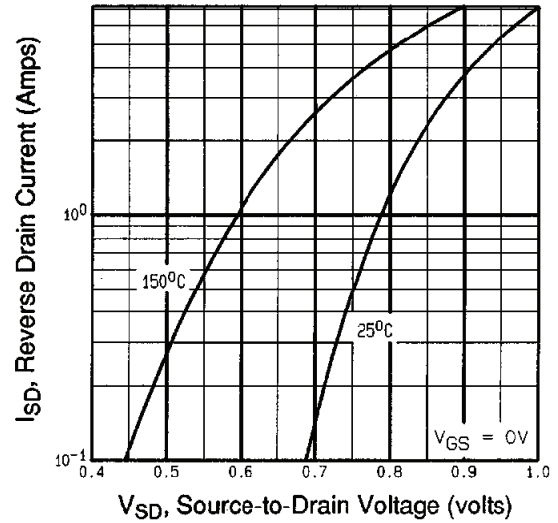


Fig. 7 - Typical Source-Drain Diode Forward Voltage

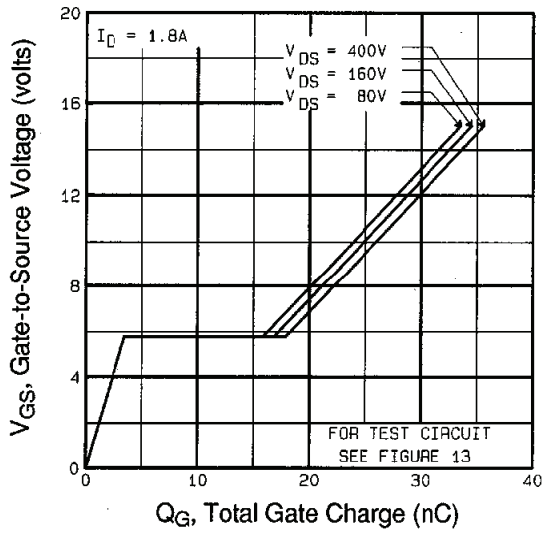


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

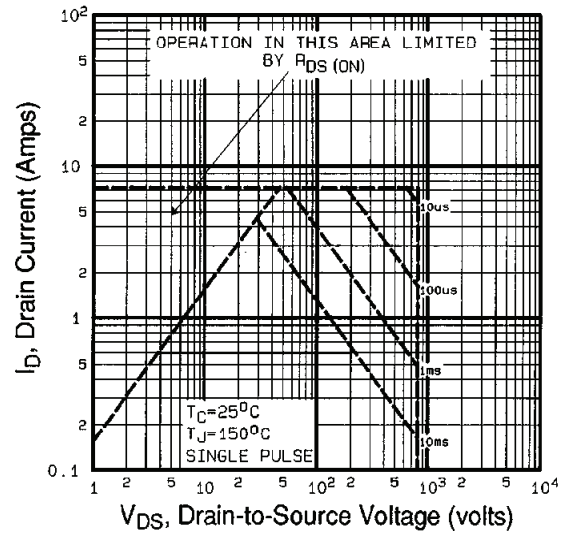


Fig. 8 - Maximum Safe Operating Area

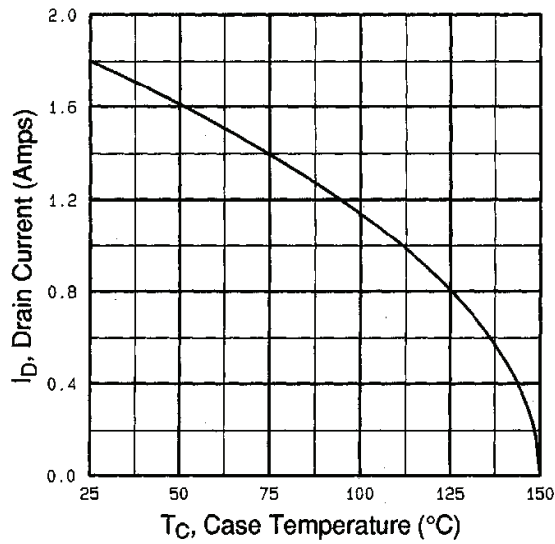


Fig. 9 - Maximum Drain Current vs. Case Temperature

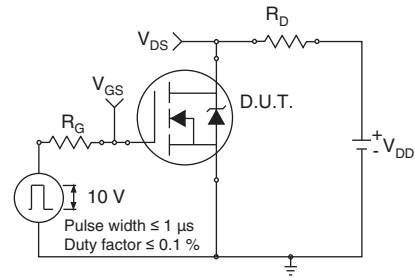


Fig. 10a - Switching Time Test Circuit

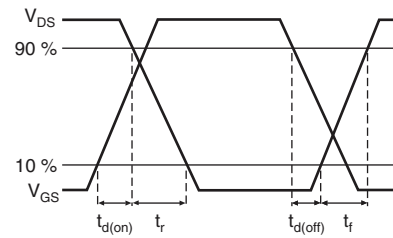


Fig. 10b - Switching Time Waveforms

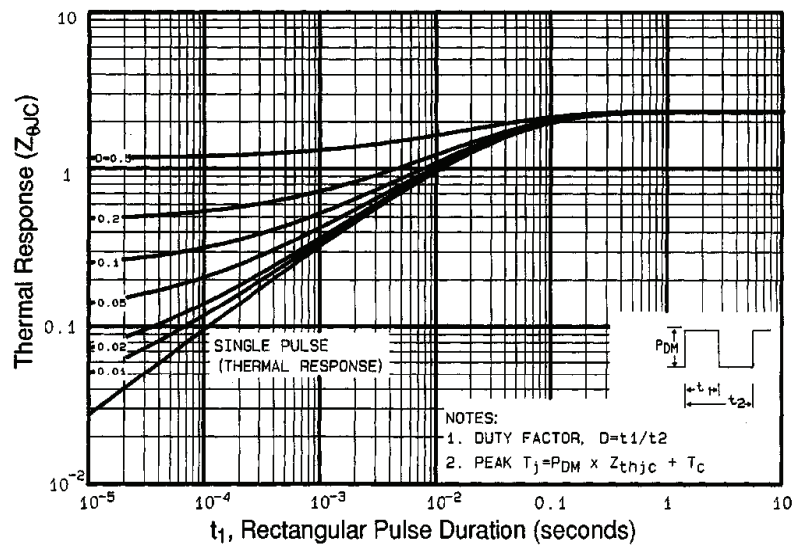


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

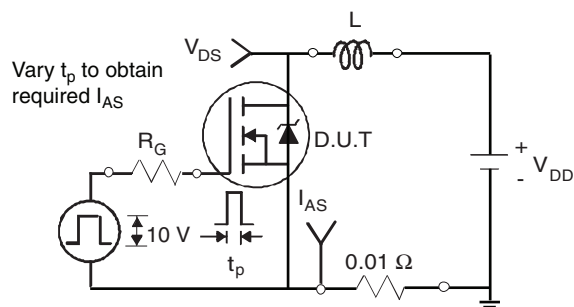


Fig. 12a - Unclamped Inductive Test Circuit

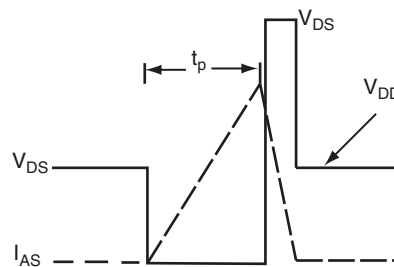


Fig. 12b - Unclamped Inductive Waveforms

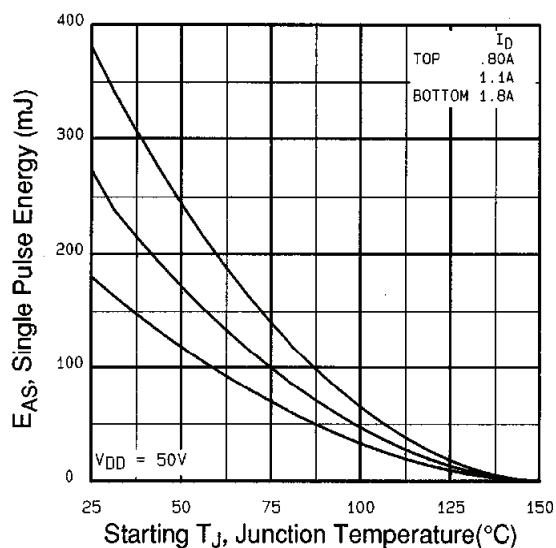


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

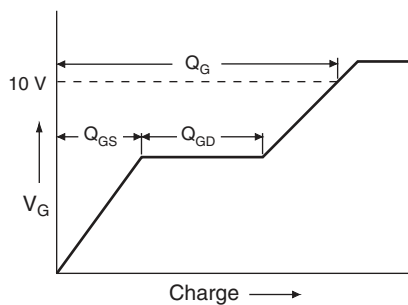


Fig. 13a - Basic Gate Charge Waveform

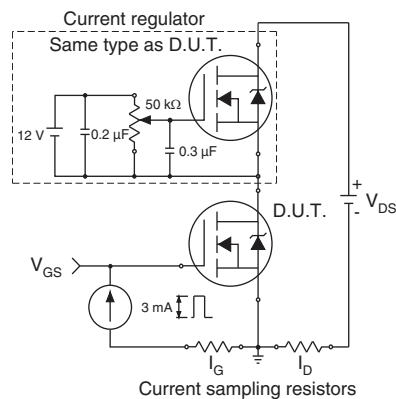
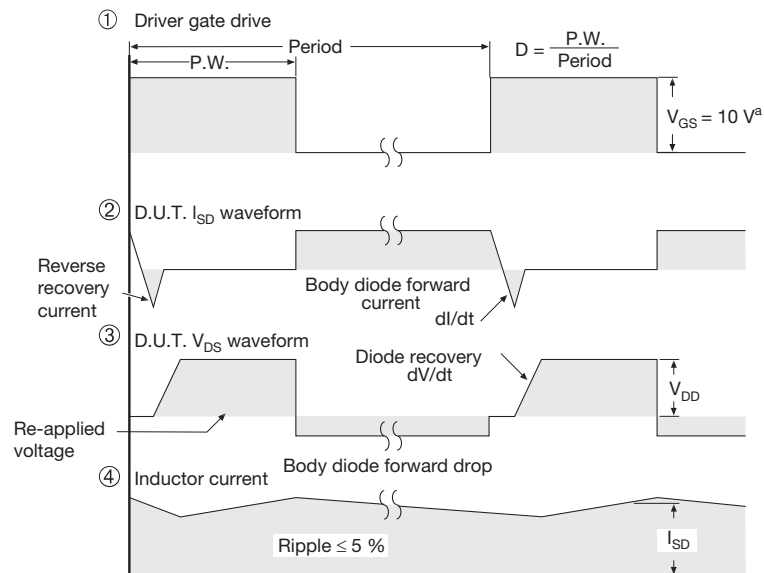
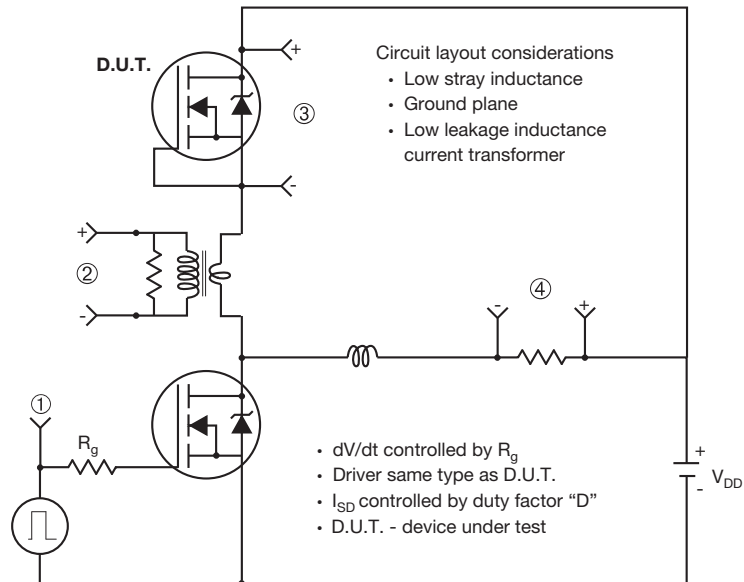


Fig. 13b - Gate Charge Test Circuit

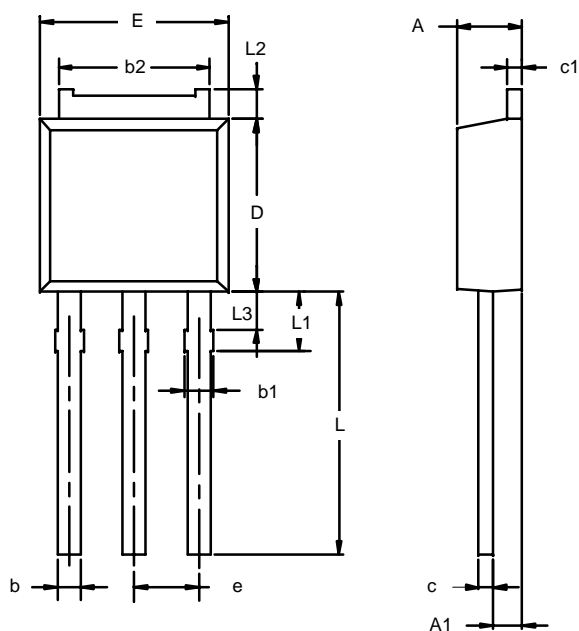
### Peak Diode Recovery dV/dt Test Circuit



**Note**

a.  $V_{GS} = 5 V$  for logic level devices

**Fig. 14 - For N-Channel**

**TO-251AA (DPAK)**

Note: Dimension L3 is for reference only.

| Dim       | MILLIMETERS |      | INCHES    |       |
|-----------|-------------|------|-----------|-------|
|           | Min         | Max  | Min       | Max   |
| <b>A</b>  | 2.21        | 2.38 | 0.087     | 0.094 |
| <b>A1</b> | 0.89        | 1.14 | 0.035     | 0.045 |
| <b>b</b>  | 0.71        | 0.89 | 0.028     | 0.035 |
| <b>b1</b> | 0.76        | 1.14 | 0.030     | 0.045 |
| <b>b2</b> | 5.23        | 5.43 | 0.206     | 0.214 |
| <b>c</b>  | 0.46        | 0.58 | 0.018     | 0.023 |
| <b>c1</b> | 0.46        | 0.58 | 0.018     | 0.023 |
| <b>D</b>  | 5.97        | 6.22 | 0.235     | 0.245 |
| <b>E</b>  | 6.48        | 6.73 | 0.255     | 0.265 |
| <b>e</b>  | 2.28 BSC    |      | 0.090 BSC |       |
| <b>L</b>  | 3.89        | 9.53 | 0.153     | 0.375 |
| <b>L1</b> | 1.91        | 2.28 | 0.075     | 0.090 |
| <b>L2</b> | 0.89        | 1.27 | 0.035     | 0.050 |
| <b>L3</b> | 1.15        | 1.52 | 0.045     | 0.060 |

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